Daytona Section Newsletter and Voting Notice
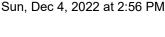
1 message

IEEE eNotice <enotice@enotice.ieee.org>   Sun, Dec 4, 2022 at 2:56 PM
Reply-To: Allan Jusko <a.jusko@ieee.org>
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DAYTONA SECTION 2023 OFFICERS ELECTION

The IEEE is using an eVoting program for all Sections to better enable members to participate in choosing the Section's officers for the upcoming year.

Members will be receiving an eNotice shortly listing the proposed candidates for the elected positions, with provision for write-in candidates if desired. We welcome and encourage all members to participate in the voting process.

OUTGOING CHAIRS COLUMN

Here we are again. The terms for the 2021-2022 Daytona Executive Committee are coming to an end. Voting will begin over the next few weeks and each of you are invited to take part as we are expected to have a few open positions. Announcements will be made in the coming weeks for the voting, which will be conducted through the IEEE Voting portal.

I would like to thank the current ExCom for their sacrifice and dedication to the Daytona Section. We would not have grown, endured, or thrived during the turmoil of the last 24 months, but we did. Specifically, I would like to thank Dr. Jianhua Liu, Vice Chair for the successful topics and meetings over the last year and his willingness to try new things, such as Zoom meetings. He also graciously covered meetings where I had scheduling conflicts arise. I would also like to thank Dr. Helen Hernandez for taking on our Website and Social Media presence, a problematic task to say the least, but one she graciously prevailed. I owe the biggest gratitude to Allan Jusko and Ron Gedney, without whom the Daytona section may look distinctly different than it does today. Ron thank you for many years of service to the Section as secretary, may you find success in your future endeavors. Allan, thank you for the many conversations and insight along the way. Lastly, I would like to thank Rebecca DeMarco for the significant improvement with student engagement at area universities. Rebecca has also inaugurated the Daytona Women in Engineering (WIE) affinity group, where the last meeting had an impressive turn out – even larger than some of the section meetings pre-COVID. Dr. Keith Garfield thank you for efforts at ERAU, though largely unseen they have not gone unnoticed.

We have traveled some interesting times during the last two years and have thrived despite COVID19. We successfully integrated the Small Radio Telescope at the Burns Science and Technology Charter School, while continuing to make it better and easier to use. Additionally, we donated the retired components for use in another application at another College. We have also launched the WIE affinity group and formalized student activities. We also held, several very successful, town meetings at BCU and ERAU.

I tend to measure success by the way people are affected. This year we have had several of the largest meetings in the Daytona Section's history, with attendance reaching 30 for some and almost 50 at the student presentations. We have changed the format of the meetings to reach an increasing general audience and it appears to be working. Despite the setbacks of COVID19 I believe the Daytona Section is better than this ExCom received it and we gladly hand it off to the future with hope and encouragement.

In closing, we have learned that the success, health, and influence of the Section can be attributed to passion, engagement, and networking. The secret of our success: students, where the Daytona Section flourishes, surpasses, and overcomes stagnation and apathy. Moving forward, I would urge the Daytona Section to increase student engagement, involvement, and integration.

Dr. W. Shawn Wilkerson, Chair

Daytona Section : https://r3.ieee.org/daytona/

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